

# STP7NB40 STP7NB40FP

## N - CHANNEL ENHANCEMENT MODE PowerMESH<sup>TM</sup> MOSFET

TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	ID
STP7NB40	400 V	< 0.9 Ω	7.0 A
STP7NB40FP	400 V	< 0.9 Ω	4.4 A

- TYPICAL R<sub>DS(on)</sub> = 0.75 Ω
- EXTREMELY HIGH dV/dt CAPABILITY
- 100% AVALANCHE TESTED
- VERY LOW INTRINSIC CAPACITANCES
- GATE CHARGE MINIMIZED

### DESCRIPTION

Using the latest high voltage MESH OVERLAY<sup>TM</sup> process, SGS-Thomson has designed an advanced family of power MOSFETs with outstanding performances. The new patent pending strip layout coupled with the Company's proprietary edge termination structure, gives the lowest RDS(on) per area, exceptional avalanche and dv/dt capabilities and unrivalled gate charge and switching characteristics.

### **APPLICATIONS**

dv/dt(1)

Viso

T<sub>sta</sub>

- HIGH CURRENT, HIGH SPEED SWITCHING
- SWITCH MODE POWER SUPPLIES (SMPS)

Peak Diode Recovery voltage slope

Insulation Withstand Voltage (DC)

Storage Temperature

DC-AC CONVERTERS FOR WELDING EQUIPMENT AND UNINTERRUPTIBLE POWER SUPPLIES AND MOTOR DRIVE

**ABSOLUTE MAXIMUM RATINGS** Symbol Parameter Value STP7NB40FP STP7NB40 Drain-source Voltage ( $V_{GS} = 0$ ) 400 VDS 400  $V_{DGR}$ Drain- gate Voltage ( $R_{GS} = 20 \text{ k}\Omega$ ) Vgs Gate-source Voltage ± 30 Drain Current (continuous) at T<sub>c</sub> = 25 °C ID 7 4.4 Drain Current (continuous) at  $T_c = 100$  °C 4.4 2.8 ID Drain Current (pulsed) 28  $I_{DM}(\bullet)$ 28 Total Dissipation at  $T_c = 25$  °C  $P_{tot}$ 100 35 **Derating Factor** 0.8 0.28

Max. Operating Junction Temperature 150 Ti (•) Pulse width limited by safe operating area (1)  $I_{SD} \le 7A$ , di/dt  $\le 200 \text{ A}/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $Tj \le T_{JMAX}$ 

This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice. January 1998 1/4



Unit

V

V

V

А

А

А

W

W/°C

V/ns

V °C

°C

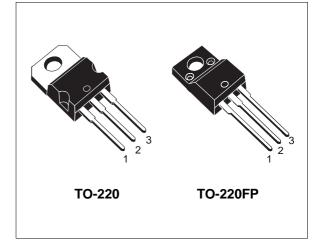
4.5

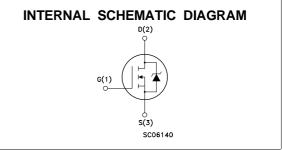
2000

-65 to 150

4.5

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### THERMAL DATA

			TO-220	TO-220FP	
R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	1.25	3.57	°C/W
R <sub>thj-amb</sub> R <sub>thc-sink</sub> T <sub>I</sub>	Thermal Resistance Junction-ambient Thermal Resistance Case-sink Maximum Lead Temperature For Soldering P	Max Typ urpose	62 0 30	.5	°C/W °C/W °C

### **AVALANCHE CHARACTERISTICS**

Symbol	Parameter	Max Value	Unit
I <sub>AR</sub>	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta < 1\%$ )	7	A
E <sub>AS</sub>	Single Pulse Avalanche Energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V)	300	mJ

# **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25 \ ^{\circ}C$ unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A$ $V_{GS} = 0$	400			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0)	$V_{DS} = Max Rating$ $V_{DS} = Max Rating$ $T_c = 125 °C$			1 50	μΑ μΑ
I <sub>GSS</sub>	Gate-body Leakage Current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 30 V$			± 100	nA

### ON (\*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ $I_D = 250 \ \mu A$	3	4	5	V
$R_{DS(on)}$	Static Drain-source On Resistance	$V_{GS} = 10V I_D = 3.5 A$		0.75	0.9	Ω
I <sub>D(on)</sub>	On State Drain Current	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $V_{GS} = 10 V$	7			A

### DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g <sub>fs</sub> (*)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_{D} = 3.5 \text{ A}$	2.5	4.2		S
Ciss C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 V f = 1 MHz V_{GS} = 0$		705 132 17	720 175 25	pF pF pF



### ELECTRICAL CHARACTERISTICS (continued)

### SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on Time Rise Time			11.5 7.5	16 11	ns ns
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 320 \text{ V}$ $I_D = 7 \text{ A}$ $V_{GS} = 10 \text{ V}$		21 7.3 8.5	30	nC nC nC

### SWITCHING OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>f</sub>	0	$V_{DD} = 320 \text{ V}$ $I_D = 7 \text{ A}$ $R_G = 4.7 \Omega$ $V_{GS} = 10 \text{ V}$ (see test circuit, figure 5)		9.5 9 16.5	15 14 25	ns ns ns

### SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> I <sub>SDM</sub> (●)	Source-drain Current Source-drain Current (pulsed)				7 28	A A
V <sub>SD</sub> (*)	Forward On Voltage	$I_{SD} = 7 \text{ A}$ $V_{GS} = 0$			1.6	V
t <sub>rr</sub>	Reverse Recovery Time	$I_{SD} = 7 \text{ A}$ di/dt = 100 A/µs V <sub>DD</sub> = 100 V T <sub>i</sub> = 150 °C		300		ns
Qrr	Reverse Recovery Charge	(see test circuit, figure 5)		2		μC
I <sub>RRM</sub>	Reverse Recovery Current			13.7		A

(\*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(•) Pulse width limited by safe operating area



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